

Table of Contents:

Efficiency and losses for both Vout at 0.9V and at 0.85V	pages 1-2
Efficiency and losses for Vout at 0.9V and low side CSD16325 removed	page 2
Output Ripple for Vout at 0.9V	page 3
Bode Plots for Vout at 0.9V	page 4
Step load & load dump for Vout at 0.9V	page 5
Short circuit and recovery	page 6
Qq	

Efficiency and losses vs. load for Vout set at 0.9V:

Airflow about 200 LFM or 1.3Meter per second: 263kHz operation

Chokes PA2202.321NL

Vin Volts	Iin A	Vout Volts	Iout A	% Efficiency	Losses in W
5.000	24.7	0.901	120.0	87.5	15.380
5.000	22.45	0.901	110.0	88.3	13.140
5.000	20.2	0.901	100.0	89.2	10.900
4.999	19.35	0.901	96.0	89.4	10.235
4.999	18.05	0.901	90.0	89.9	9.142
5.000	15.9	0.901	80.0	90.7	7.420
5.000	13.83	0.901	70.0	91.2	6.080
4.999	11.78	0.901	60.0	91.8	4.828
5.000	9.75	0.901	50.0	92.4	3.700
4.999	7.8	0.901	40.0	92.4	2.952
4.999	5.85	0.901	30.0	92.4	2.214
4.999	3.95	0.901	20.0	91.3	1.726
5.000	2.1	0.901	10.0	85.8	1.490
5.000	0.25	0.901	0	0.0	1.250

For 32A per output or 96A in all I had estimated 90 to 90.8% efficiency. I measured the copper path drops in the 6 power trains, and they came to 29.3mV on the average vs. 16.25mV drop I had used in my estimations. This added 13mV times 96A is 1.25W. If this added loss can be eliminated by improving the copper paths, then losses will be reduced from 10.235W to 8.985W, and efficiency improved from 89.4% to 90.6%.

Efficiency and losses vs. load for Vout set at 0.85V:

R12 set to 46.4k (from 34.8k for 0.9V setting)

Airflow about 200 LFM or 1.3Meter per second: 263kHz operation

Chokes PA2202.321NL

Vin Volts	Iin A	Vout Volts	Iout A	% Efficiency	Losses in W
5.000	23.45	0.851	120.0	87.1	15.130
5.000	19.15	0.851	100.0	88.9	10.650
5.000	18.35	0.851	96.0	89.0	10.054
4.999	15.10	0.851	80.0	90.2	7.405
5.000	11.15	0.851	60.0	91.6	4.690
4.999	7.40	0.8515	40.0	92.1	2.933
5.000	3.75	0.852	20.0	90.9	1.710
5.000	0.25	0.852	0	0.0	1.250

Reducing Vout does reduce losses slightly for a given Iout. This saving varies from 250mW at max load down to near zero at no load. At 96A savings is 180mW. This is due to the high side FET with its higher on resistance conducting less of the period. However, the lower output power when Vout is 0.85V vs. 0.9V causes the efficiencies to be lower.

Efficiency and losses vs. load for Vout set at 0.9V: with the six Q11-Q66 CSD16325s removed:

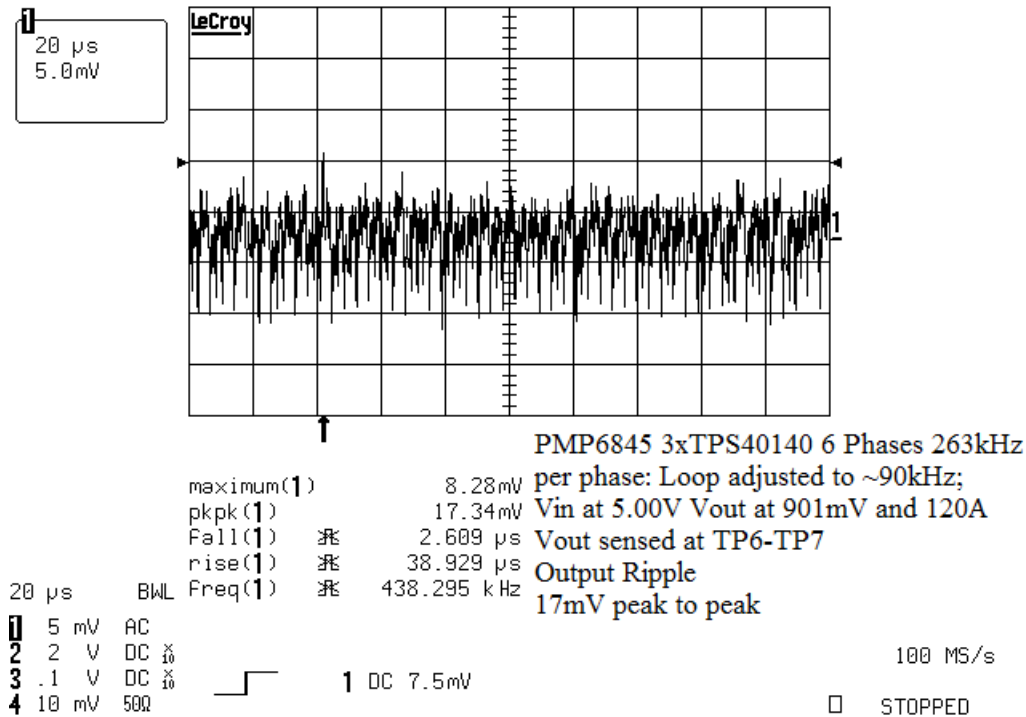
Airflow about 200 LFM or 1.3Meter per second: 263kHz operation

Chokes PA2202.321NL

Vin Volts	Iin A	Vout Volts	Iout A	% Efficiency	Losses in W	Added loss due to tnx removal
5.000	25.25	0.900	120.0	85.5	18.250	2.87
4.999	22.90	0.900	110.0	86.5	15.477	2.34
5.000	20.60	0.9005	100.0	87.4	12.950	2.05
5.000	19.675	0.9005	96.0	87.9	11.927	1.69
5.000	18.35	0.9005	90.0	88.3	10.705	1.56
4.999	16.15	0.901	80.0	89.3	8.654	1.23
5.000	14.00	0.901	70.0	90.1	6.930	0.85
4.999	11.90	0.901	60.0	90.9	5.428	0.60
5.000	9.85	0.901	50.0	91.5	4.200	0.50
4.999	7.85	0.901	40.0	91.8	3.202	0.25
5.000	5.85	0.901	30.0	92.4	2.220	0.01
5.000	3.95	0.901	20.0	91.2	1.730	0.00
4.999	2.05	0.901	10.0	87.9	1.238	-0.25
4.999	0.20	0.901	0	0.0	1.000	-0.25

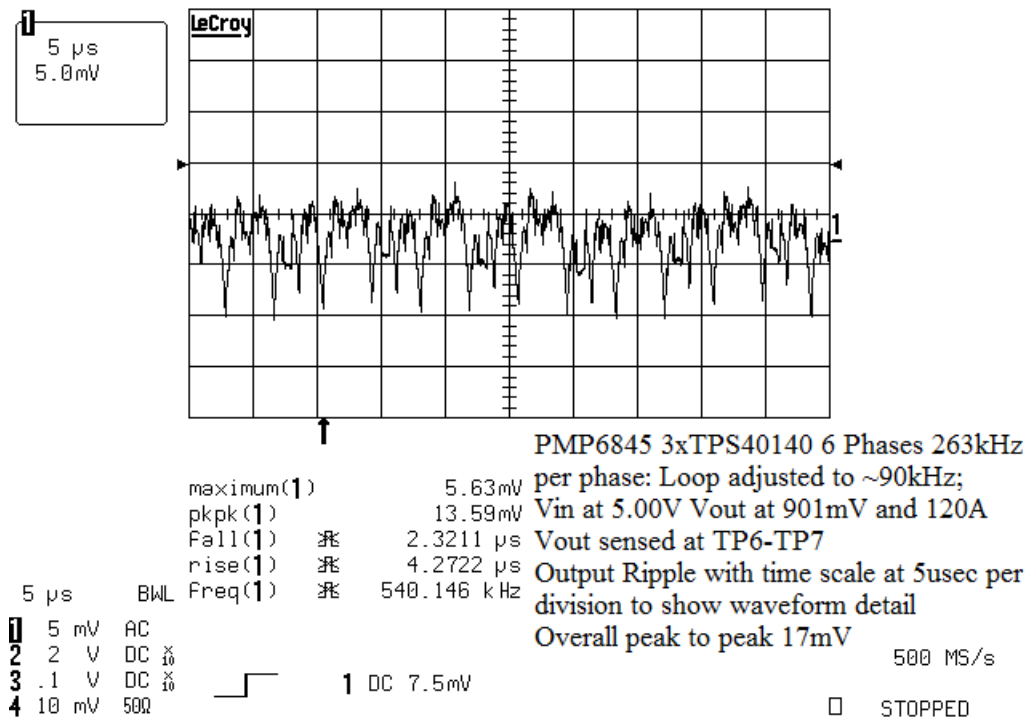
Output ripple:

1-Sep-11 Reading Floppy Disk Drive
15:04:47



Same, but time expanded to show waveform

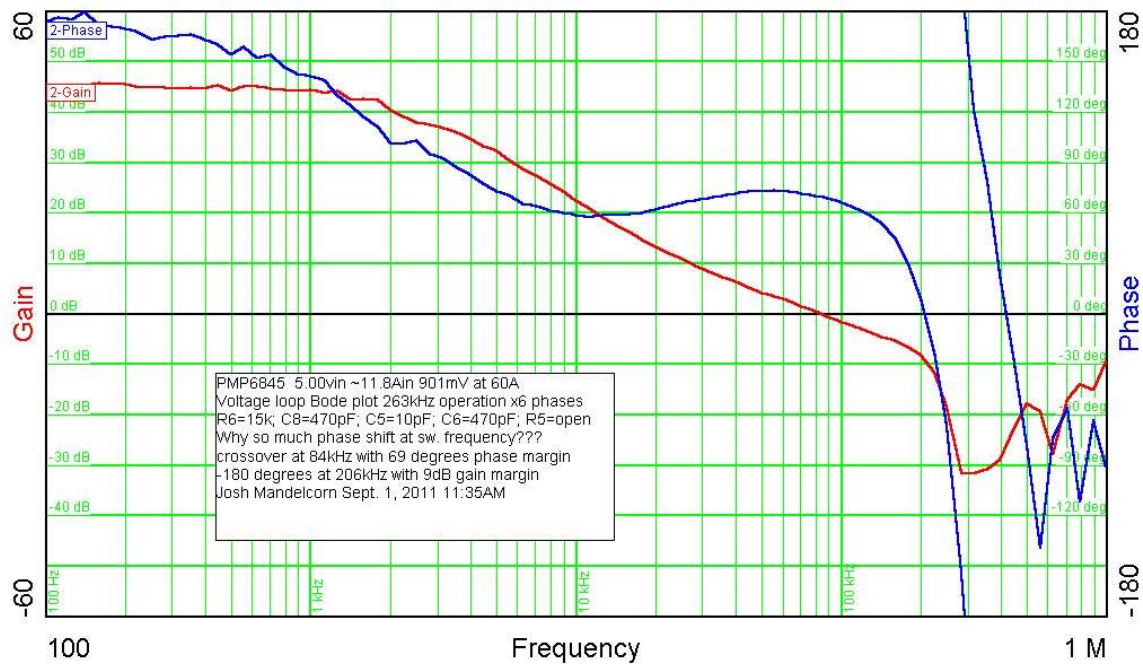
1-Sep-11
15:07:38



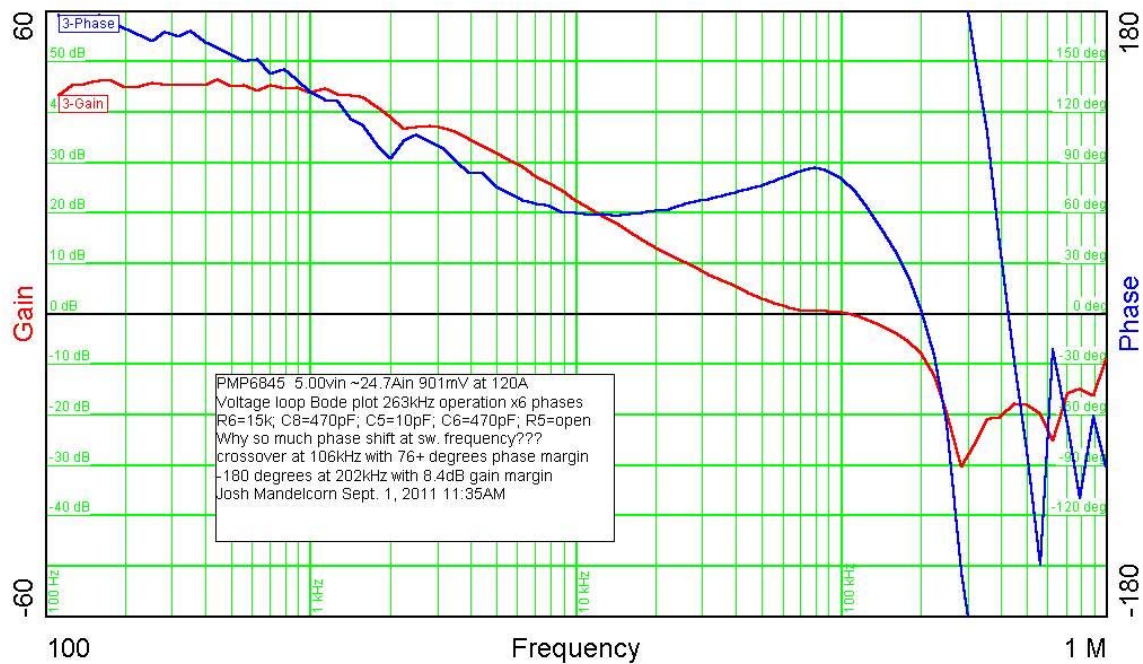
Qq

Bode plots:

Half load:

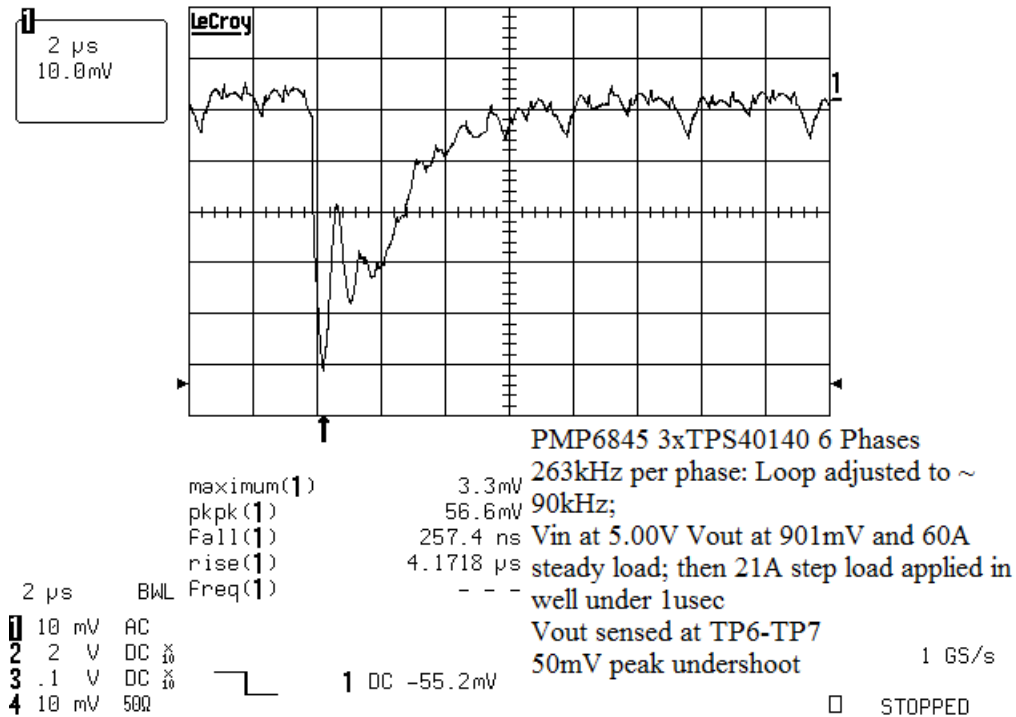


Full load:



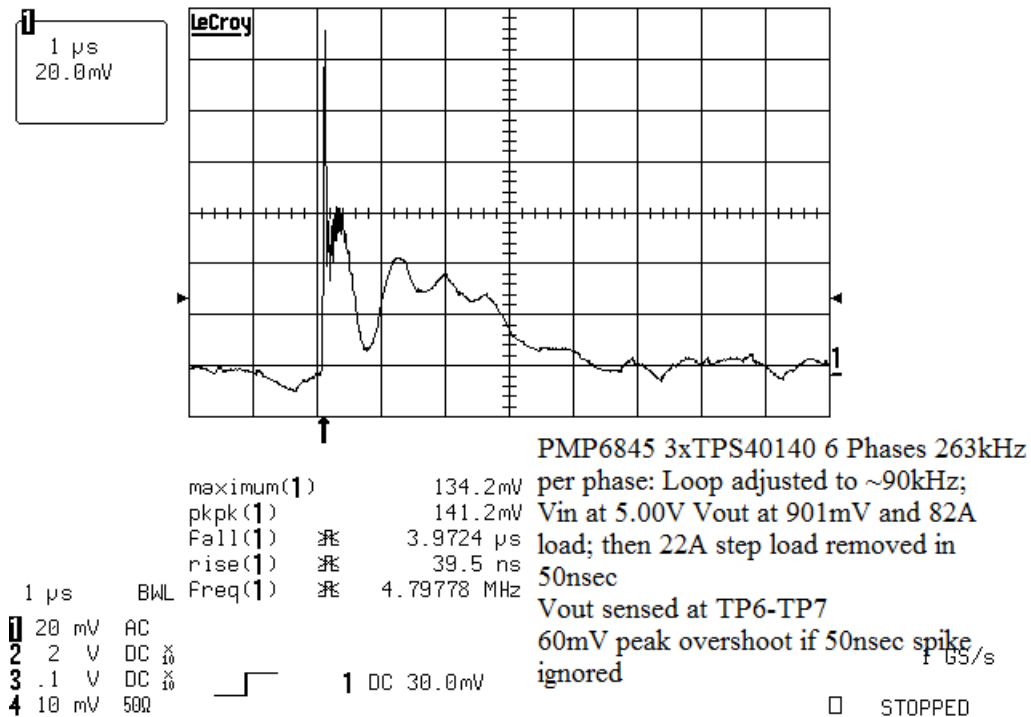
qq

Step load response:

1-Sep-11
15:15:27

Qq

Load dump response:

1-Sep-11 Reading Floppy Disk Drive
15:13:26

Qq

Short circuit and recovery:

This test was done without the added low side FETs.

A screwdriver was applied to output terminals to short output.

External Load was set to 90A off the 900mV output.

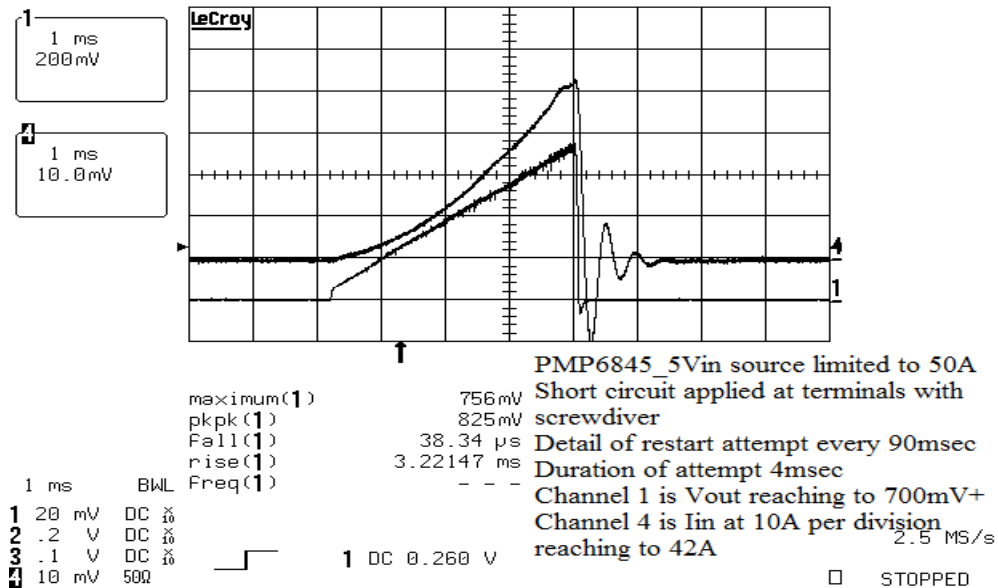
Source was set to deliver 5.0V when load at 90A, and source current limit at 50A.

Vout and Iin were monitored, as current probe used is only rated to 100A peak, well below that needed to monitor short circuit off a 120A rated output.

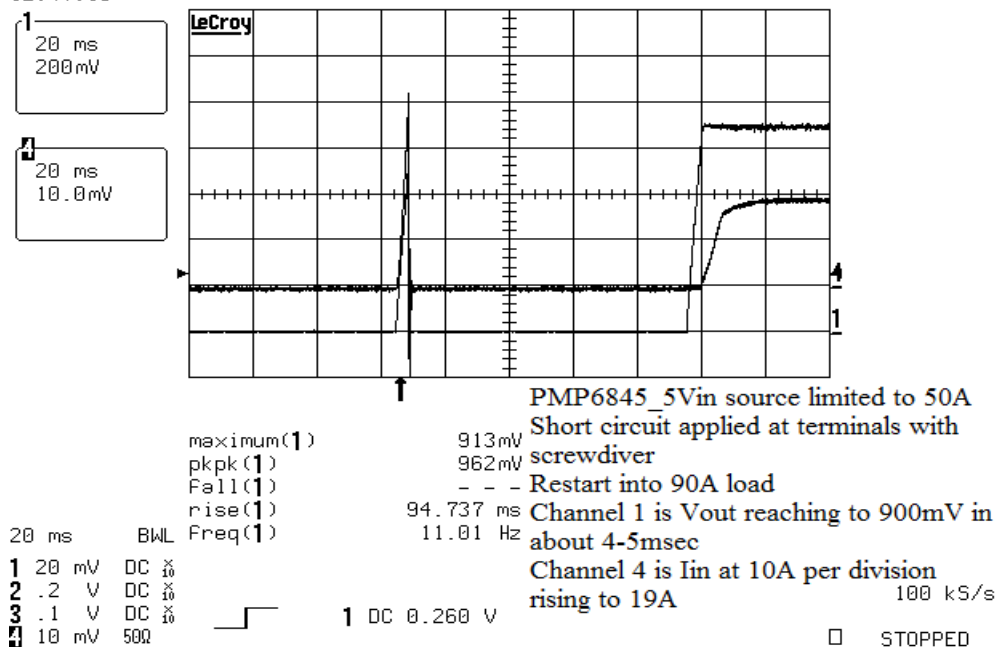
Restart attempts occurred every 90msec and lasted about 4-5msec each.

Shown below are detail of a restart attempt and a final recovery into load:

12-Sep-11
12:44:09

**Final recovery:**

12-Sep-11
12:47:18



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